# Electronic Acknowledgement Receipt FES ID: 1203401 Application Number: 10616097 Confirmation Number: 1645 Multiple-step electrodeposition process for direct copper plating on Title of Invention: barrier metals First Named Inventor: Zhi-Wen Sun Customer Number: 44257 Filer: John-Paul Francis Cherry Filer Authorized By: Attorney Docket Number: AMAT/8241/CMP/ECP/RKK Receipt Date: 15-SEP-2006 Filing Date: 08-JUL-2003 Time Stamp: 15:42:10 Application Type: Utility International Application Number: Payment information:

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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Amendment - After Non-Final Rejection	APPM_8241_ROA_EF.pdf	748248	no	16

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.